SLCS120A - AUGUST 1993 - REVISED DECEMBER 1993

- Low-Voltage and Single-Supply Operation
 V_{CC} = 2 V to 7 V
- Common-Mode Voltage Range That Includes Ground

description

The TL393 is a dual differential comparator built using a new Texas Instruments-developed bipolar process. The TL393 is intended as an enhanced alternative to the industry-standard LM393 in circuits with supply-voltage limits of 7 V.

The new bipolar process allows the TL393 to perform with lower supply-current requirements than the LM393 (0.7 mA typical) while still providing a faster response time than the older device.

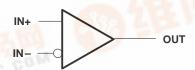
Package availability for this device includes the TSSOP (thin-shrink small-outline package). With a maximum thickness of 1.1 mm and a package area that is 25% smaller than the standard surface-mount package, the TSSOP is ideal for high-density circuits, particularly in hand-held and portable equipment.

AVAILABLE OPTIONS

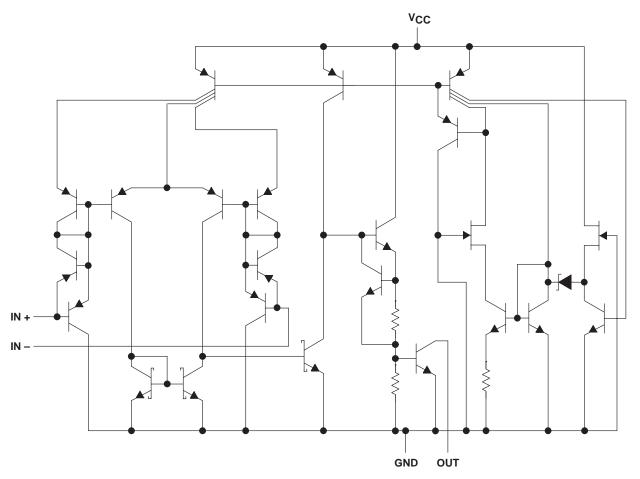
	SUPPLY RESPONSE TIME		PAC	CHIP FORM			
TA	CURRENT (TYP)	(TYP)	SMALL OUTLINE (D)	PLASTIC DIP (P)	TSSOP (PW)†	(Y)	
-40°C to 105°C	0.7 mA	0.65 μs	TL393ID	TL393IP	TL393IPWLE	TL393Y	

The PW packages are only available left-ended taped and reeled (e.g., TL393IPWLE).

symbol (each comparator)



equivalent schematic (each comparator)

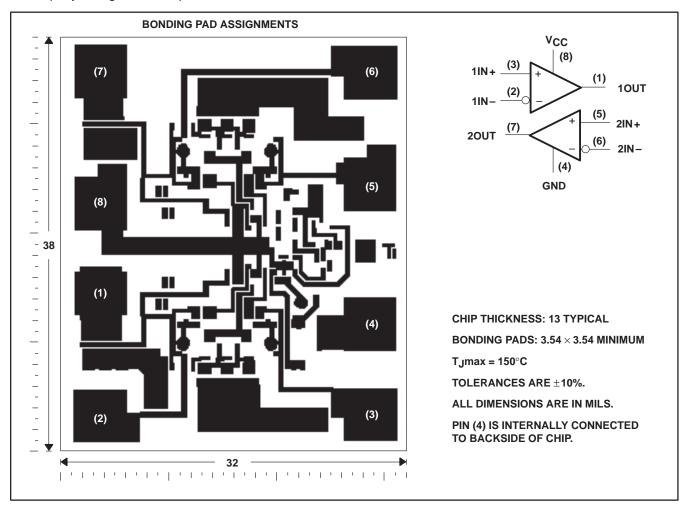


COMPONENT COUNT					
Transistors	48				
Resistors	5				
Diodes	7				
Epi-FETs	2				

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TL393Y chip information

This chip, when properly assembled, displays characteristics similar to the TL393. Thermal compression or ultrasonic bonding may be used on the doped-aluminum bonding pads. Chips may be mounted with conductive epoxy or a gold-silicon preform.



TL393, TL393Y DUAL DIFFERENTIAL COMPARATORS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

0 and allow V (and Nate 4)	7.1/
Supply voltage, V _{CC} (see Note 1)	
Differential input voltage, V _{ID} (see Note 2)	7 V
Input voltage, V _I (any input)	7 V
Output voltage, V _O	7 V
Output current, IO (each output)	20 mA
Duration of short-circuit current to GND (see Note 3)	unlimited
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature range, T _A	–40°C to 105°C
Storage temperature range	65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential voltages, are with respect to network GND.

- 2. Differential voltages are at IN+ with respect to IN -.
- 3. Short circuits from the outputs to V_{CC} can cause excessive heating and eventual destruction of the chip.

DISSIPATION RATING TABLE

PACKAGE	$T_{\mbox{$A$}} \leq 25^{\circ}\mbox{$C$}$ POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING
D	725 mW	5.8 mW/°C	464 mW	377 mW
Р	1000 mW	8.0 mW/°C	640 mW	520 mW
PW	525 mW	4.2 mW/°C	336 mW	273 mW

recommended operating conditions

	MIN	MAX	UNIT
Supply voltage, V _{CC}	2	7	V
Operating free-air temperature, T _A	-40	105	°C



TL393, TL393Y DUAL DIFFERENTIAL COMPARATORS

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electrical characteristics, V_{CC} = 5 V (unless otherwise noted)

	PARAMETER	TEST CONDITIONS		T. A	TL393			UNIT	
	PARAMETER	IESI CO	SNOTTIONS	T _A †	MIN	TYP	MAX	ONIT	
V. 0	Input offset voltage	\\a - 1.4.\\	Via – Vianmin	25°C		1.5	5	mV	
VIO	Input offset voltage	$V_O = 1.4 \text{ V}, V_{IC} = V_{ICR} \text{mir}$		Full range			9	IIIV	
Vian	Common-mode input voltage range			25°C	0 to V _{CC} –1.5	0 to V _{CC} -1.2		V	
VICR	Common-mode input voitage range			Full range	0 to V _{CC} –2			V	
Vai	Low-level output voltage	$V_{ID} = -1 V$,	I _{OL} = 1 mA	25°C		70	300	mV	
VOL	Low-level output voltage	$V_{ID} = -1 V$,	I _{OL} = 4 mA	Full range		200	700	IIIV	
li a	Input offset current	V _O = 1.4 V		25°C		5	50	nA	
ΙO				Full range			150		
1	lanut biog gurrant	V- 44V		25°C		-40	-250	nA	
IB	Input bias current	V _O = 1.4 V		Full range			-400	IIA	
	High level cutrout current	V _{ID} = 1 V,	V _{OH} = 3 V	25°C		0.1		nA	
ІОН	High-level output current	V _{ID} = 1 V,	V _{OH} = 5 V	Full range			100	IIA	
loL	low-level output current	$V_{ID} = -1 V$,	V _{OL} = 1.5 V	25°C	6			mA	
	High lovel events everent	V _O = V _{OH}		25°C		140	200		
ICCH	High-level supply current			Full range			300	μΑ	
lası	Low level cumply current	\\a - \\a;	•	25°C		0.8	1		
ICCL	Low-level supply current	VO = VOL		Full range			1.2	mA	

[†] Full range is –40°C to 105°C.

switching characteristics, V_{CC} = 5 V, C_L = 15 pF, T_A = 25°C

PARAMETER	TEST CON	DITIONS	TL393 MIN TYP MAX			UNIT
FARAWETER	1E31 CON	DITIONS				UNIT
Response time	100-mV input step with 5-mV overdrive,	R _L connected to 5 V through 5.1 k Ω		0.65		
Response time	TTL-level input step,	R_L connected to 5 V through 5.1 $k\Omega$		0.2		μs

TL393, TL393Y DUAL DIFFERENTIAL COMPARATORS

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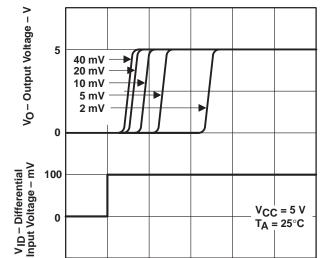
electrical characteristics, V_{CC} = 5 V, T_A = 25°C (unless otherwise noted)

	DADAMETED	TEST CONDITIONS		UNIT		
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNII
VIO	Input offset voltage	V _O = 1.4 V,		1.5	5	mV
VICR	Common-mode input voltage range		0 to V _{CC} -1.5	0 to V _{CC} -1.2		V
VOL	Low-level output voltage	$V_{ID} = -1 \text{ V}, I_{OL} = 1 \text{ mA}$		70	300	mV
lio	Input offset current	V _O = 1.4 V		5	50	nA
I _{IB}	Input bias current	V _O = 1.4 V		-40	-250	nA
IOH	High-level output current	$V_{ID} = 1 \text{ V}, V_{OH} = 3 \text{ V}$		0.1		nA
lOL	low-level output current	$V_{ID} = -1 \text{ V}, V_{OL} = 1.5 \text{ V}$	6			mA
Іссн	High-level supply current	Vo = VoH		140	200	μΑ
ICCL	Low-level supply current	$V_O = V_{OL}$		0.8	1	mA

switching characteristics, V_{CC} = 5 V, C_L = 15 pF, T_A = 25°C

PARAMETER	TEST COND	SIGNITION	1	UNIT		
PARAMETER	TEST CONL	OTTIONS	MIN TYP MAX			UNIT
Response time	100-mV input step with 5-mV overdrive,	R _L connected to 5 V through 5.1 k Ω		0.65		
	TTL-level input step,	R_L connected to 5 V through 5.1 $k\Omega$		0.2		μs

TYPICAL CHARACTERISTICS



LOW- TO HIGH-LEVEL OUTPUT RESPONSE

FOR VARIOUS INPUT OVERDRIVES

Figure 1

tpLH - Low- to High-Level Output

Response Time – μ s

0.5

HIGH- TO LOW-LEVEL OUTPUT RESPONSE FOR VARIOUS INPUT OVERDRIVES

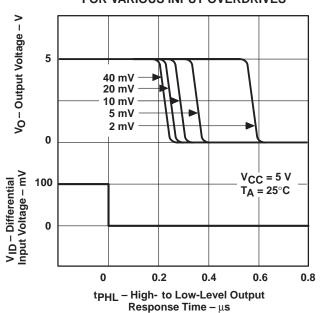


Figure 2

2.5



PACKAGE OPTION ADDENDUM

30-Mar-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)
TL393ID	OBSOLETE	SOIC	D	8	TBD	Call TI	Call TI
TL393IDR	OBSOLETE	SOIC	D	8	TBD	Call TI	Call TI
TL393IP	OBSOLETE	PDIP	Р	8	TBD	Call TI	Call TI
TL393IPWLE	OBSOLETE	TSSOP	PW	8	TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

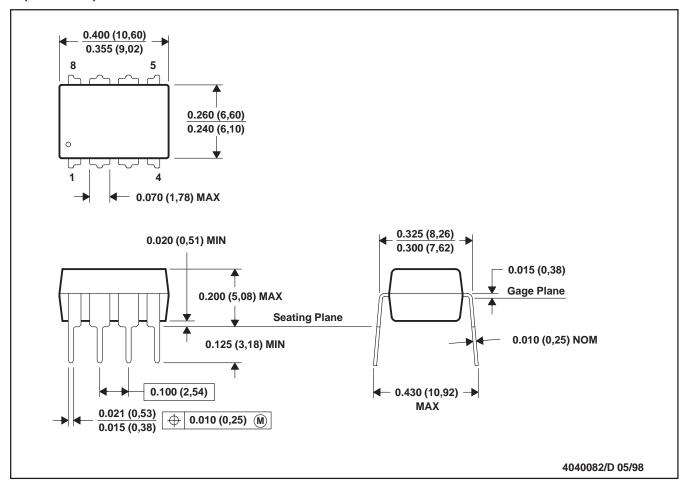
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE



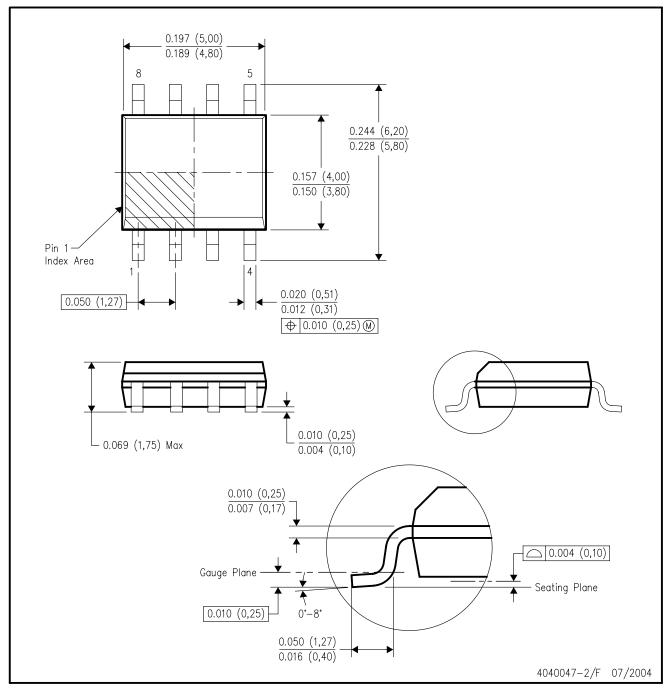
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001



D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AA.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153

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